



## General Description

The SJD02P6000 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as -10V. This device is suitable for use as a wide variety of applications.

## Features

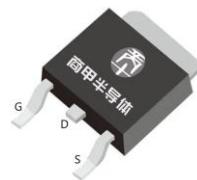
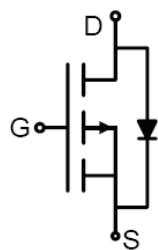
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

## Application

- PWM Applications
- Load Switch
- Power Management

## Key Performance Parametes

Parameter	Value	Unit
$V_{DS}$	-200	V
$R_{DS(ON)}_{TYP}$	642	mΩ
$I_D$	-4.5	A
$Q_G$	80	nC



Schematic Diagram

TO-252(DPAK) top view

## Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJD02P6000	SJD02P6000	TO-252	Tape	\	\	2500 Pcs

Table 1. Absolute Maximum Ratings ( $T_c=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0\text{V}$ )	-200	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0\text{V}$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_c=25^\circ\text{C}$ )	-4.5	A
	Drain Current-Continuous( $T_c=100^\circ\text{C}$ )	-2.8	A
$I_{DM}$ (pulse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	-18	A
$P_D$	Maximum Power Dissipation( $T_c=25^\circ\text{C}$ )	37.8	W
	Maximum Power Dissipation( $T_c=100^\circ\text{C}$ )	15.2	W
$E_{AS}$	Avalanche energy (Note 2)	81	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{θJC}$	Thermal Resistance, Junction-to-Case		3.3	°C/W



## 200V P-Channel Trench Power MOSFET

Table 3. Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ $I_{\text{D}}=-250\mu\text{A}$	-200			V
$I_{\text{DS}}^{\text{SS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=-200\text{V}$ , $V_{\text{GS}}=0\text{V}$ $T_J=25^\circ\text{C}$			-1	$\mu\text{A}$
		$V_{\text{DS}}=-200\text{V}$ , $V_{\text{GS}}=0\text{V}$ $T_J=125^\circ\text{C}$			-100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$			$\pm 100$	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_{\text{D}}=-250\mu\text{A}$	-2		-4	V
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}}=-10\text{V}$ , $I_{\text{D}}=-3\text{A}$		5.5		S
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=-10\text{V}$ , $I_{\text{D}}=-2\text{A}$ $T_J=25^\circ\text{C}$		642	834	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=-25\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1.0\text{MHz}$		2145		pF
$C_{\text{oss}}$	Output Capacitance			49.3		pF
$C_{\text{rss}}$	Reverse Transfer Capacitance			40.4		pF
$R_g$	Gate resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $f=1.0\text{MHz}$		5.4		$\Omega$
<b>Switching Parameters</b>						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=-10\text{V}$ , $V_{\text{DS}}=-50\text{V}$ , $R_{\text{L}}=16\Omega$ , $R_{\text{GEN}}=3\Omega$		17.3		nS
$t_r$	Turn-on Rise Time			4.2		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time			49.6		nS
$t_f$	Turn-Off Fall Time			28		nS
$Q_g$	Total Gate Charge	$V_{\text{GS}}=-10\text{V}$ , $V_{\text{DS}}=-50\text{V}$ , $I_{\text{D}}=-3\text{A}$		80		nC
$Q_{\text{gs}}$	Gate-Source Charge			15		nC
$Q_{\text{gd}}$	Gate-Drain Charge			28		nC
<b>Source-Drain Diode Characteristics</b>						
$I_{\text{SD}}$	Source-Drain Current (Body Diode)				-4.5	A
$V_{\text{SD}}$	Forward on Voltage (Note 3)	$V_{\text{GS}}=0\text{V}$ , $I_{\text{S}}=-3\text{A}$			-1.2	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_{\text{F}}=-3\text{A}$ , $dI/dt=-100\text{A}/\mu\text{s}$		63.6		ns
$Q_{\text{rr}}$	Reverse Recovery Charge	$I_{\text{F}}=-3\text{A}$ , $dI/dt=-100\text{A}/\mu\text{s}$		194		nC

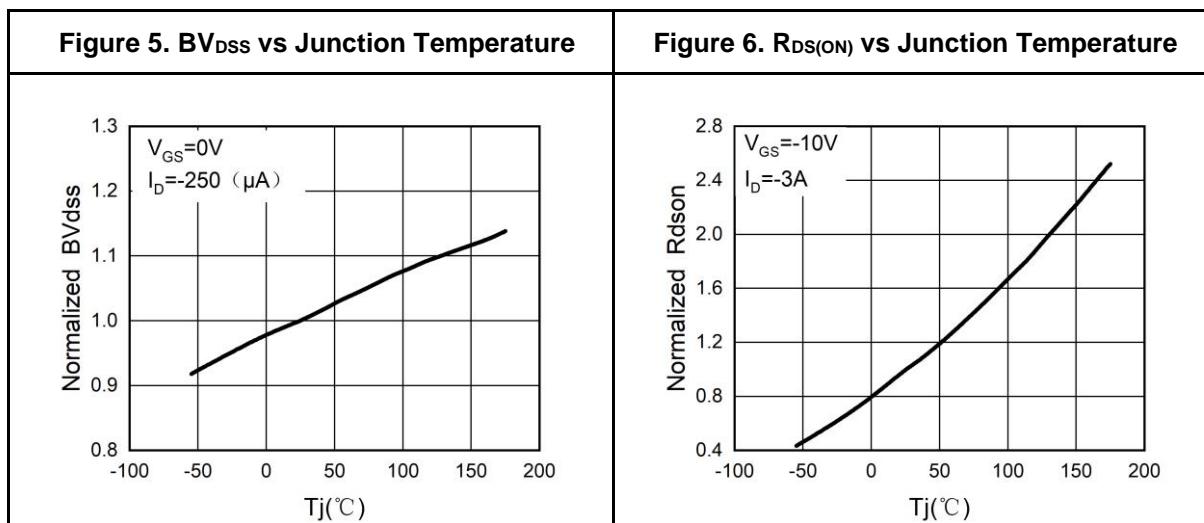
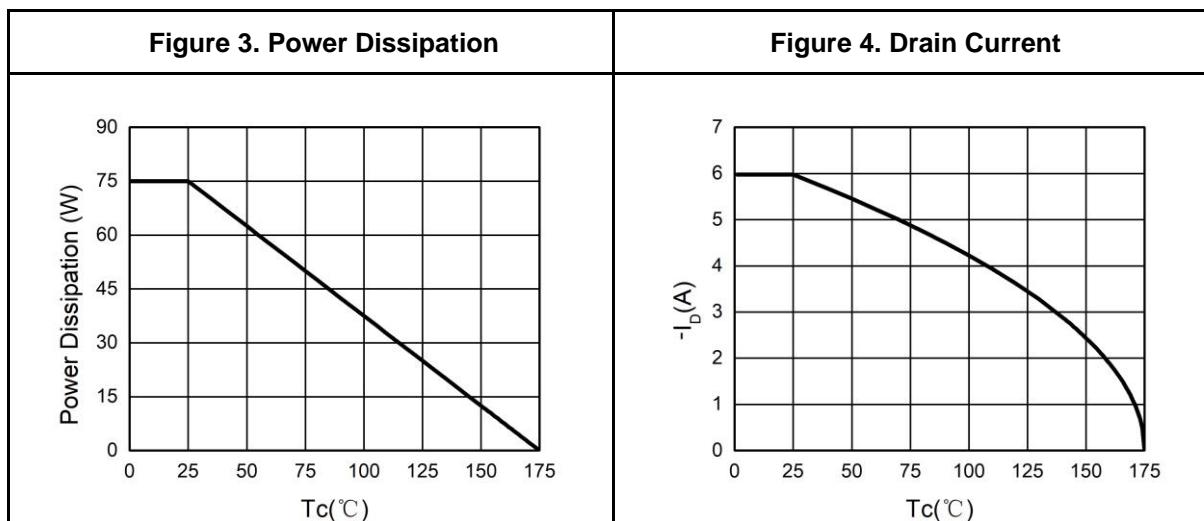
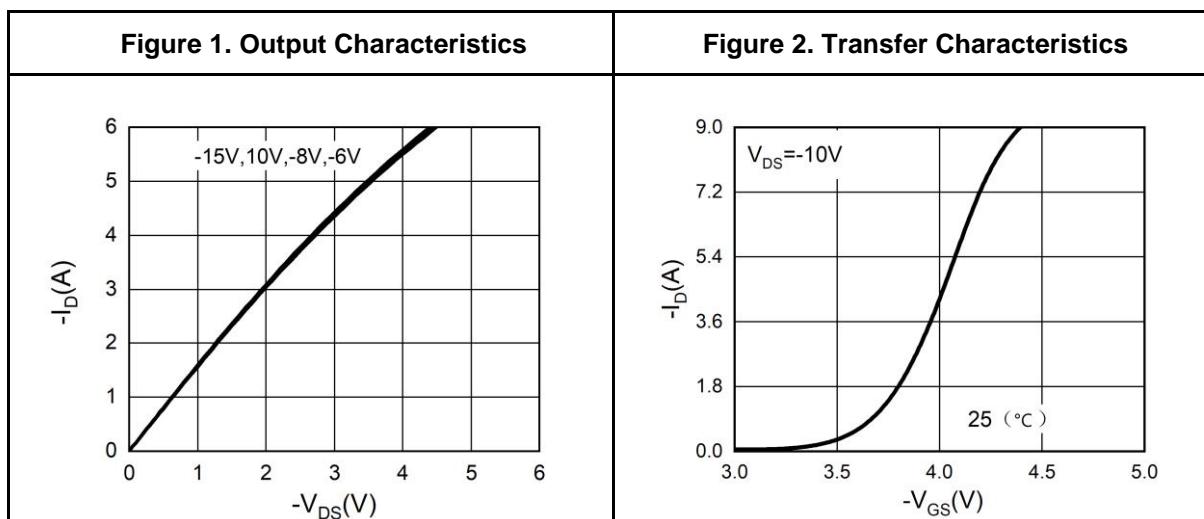
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E<sub>AS</sub> condition:  $T_J=25^\circ\text{C}$ ,  $V_{\text{DD}}=-50\text{V}$ ,  $V_{\text{G}}=-10\text{V}$ ,  $R_g=25\Omega$ ,  $L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

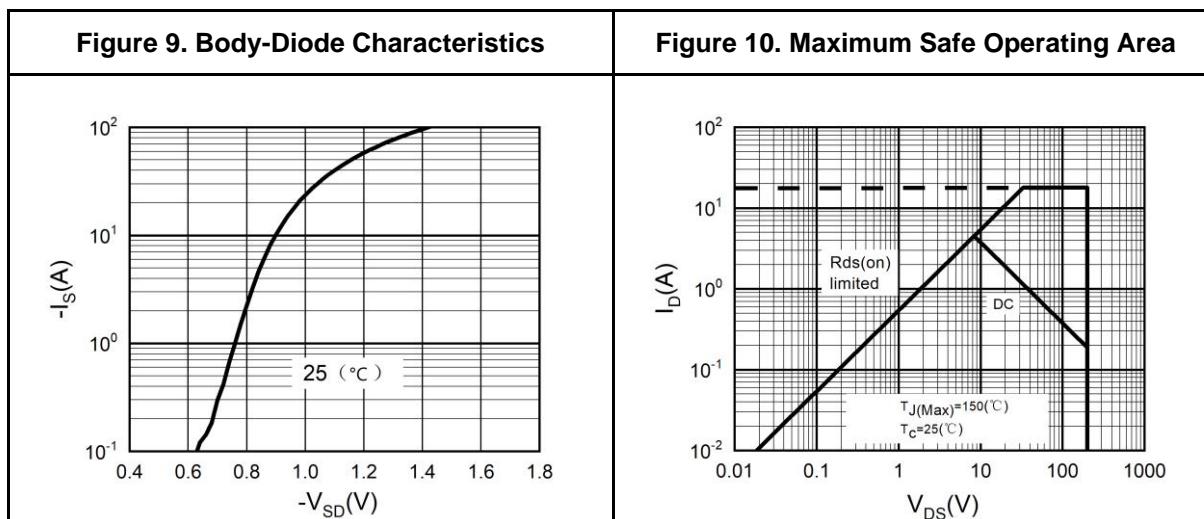
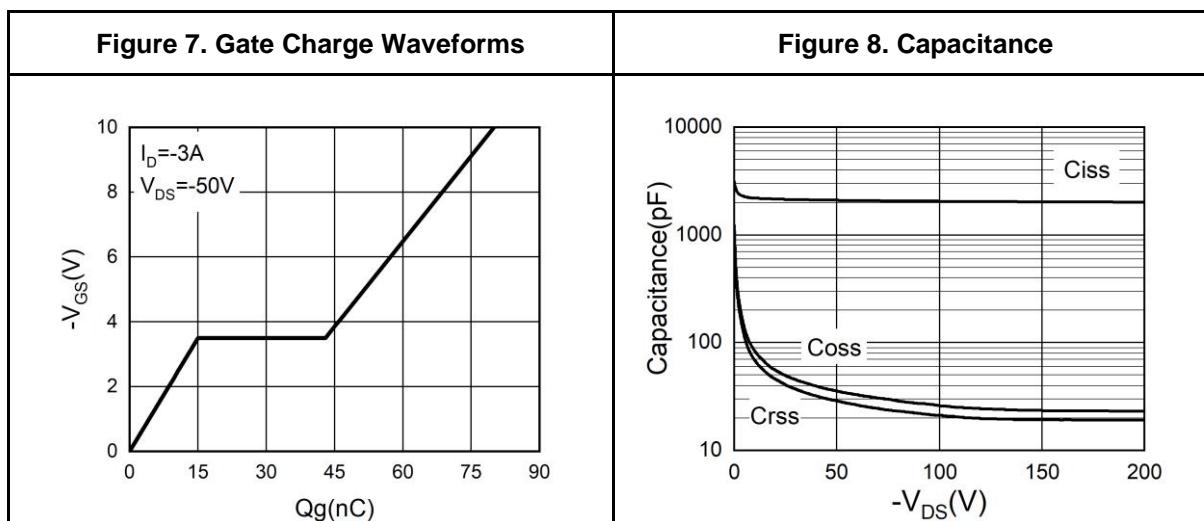


## Typical Electrical And Thermal Characteristics (Curves)



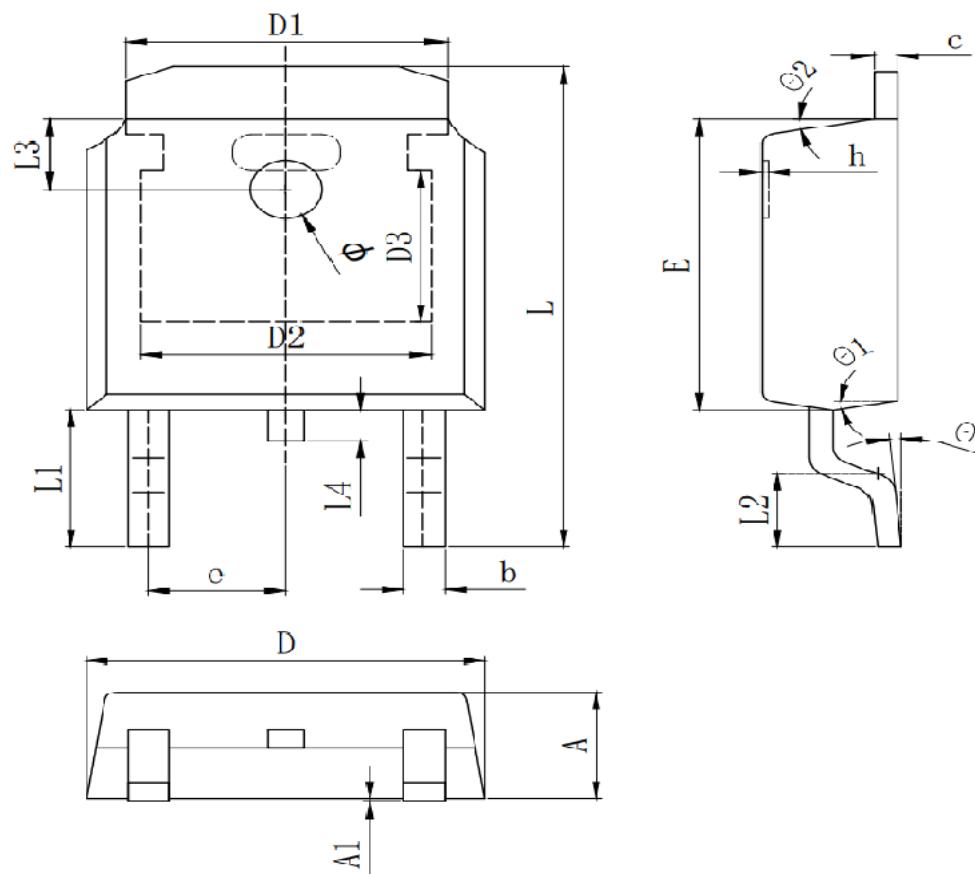


## Typical Electrical And Thermal Characteristics (Curves)





## TO-252 Package Information



Symbol	Dimensions In Millimeters		
	Min.	Typ.	Max.
A	2.200	2.300	2.400
A1	0.000		0.127
b	0.640	0.690	0.740
c(电镀后)	0.460	0.520	0.580
D	6.500	6.600	6.700
D1		5.334 REF	
D2		4.826 REF	
D3		3.166 REF	
E	6.000	6.100	6.200
e		2.286 TYP	
h	0.000	0.100	0.200
L	9.900	10.100	10.300
L1		2.888 REF	
L2	1.400	1.550	1.700
L3		1.600 REF	
L4	0.600	0.800	1.000
Φ	1.100	1.200	1.300
θ	0°		8°
θ1		9° TYP	
θ2		9° TYP	



## Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

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